

November 2007

KSD1616/1616A

Audio Frequency Power Amplifier & Medium Speed Switching

· Complement to KSB1116/1116A



Absolute Maximum Ratings Ta=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{CBO}	Collector-Base Voltage	: KSD1616 : KSD1616A	60 120	V V	
V _{CEO}	Collector-Emitter Voltage	: KSD1616 : KSD1616A	50 60	V V	
V_{EBO}	Emitter-Base Voltage		6	V	
I _C	Collector Current (DC)		1	Α	
I _{CP}	* Collector Current (Pulse)		2	Α	
P _C	Collector Power Dissipation		0.75	W	
T _J	Junction Temperature		150	°C	
T _{STG}	Storage Temperature		-55 ~ 150	°C	

^{*} PW≤10ms, Duty Cycle < 50%

Electrical Characteristics Ta=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
I _{CBO}	Collector Cut-off Current	V _{CB} =60V, I _E =0			100	nA
I _{EBO}	Emitter Cut-off Current	V _{EB} =6V, I _C =0			100	nA
h _{FE1}	DC Current Gain : KSD1616 : KSD1616A	V _{CE} =2V, I _C =100mA	135 135		600 400	
h _{FE2}		V _{CE} =2V, I _C =1A	81			
V _{BE} (on)	* Base-Emitter On Voltage	V _{CE} =2V, I _C =50mA	600	640	700	mV
V _{CE} (sat)	* Collector-Emitter Saturation Voltage	I _C =1A, I _B =50mA		0.15	0.3	V
V _{BE} (sat)	* Base-Emitter Saturation Voltage	I _C =1A, I _B =50mA		0.9	1.2	V
C _{ob}	Output Capacitance	V _{CE} =10V, I _E =0, f=1MHz		19		pF
f _T	Current Gain Bandwidth Product	V _{CE} =2V, I _C =100mA	100	160		MHz
t _{ON}	Turn On Time	V _{CC} =10V, I _C =100mA		0.07		μS
t _{STG}	Storage Time	I _{B1} = -I _{B2} =10mA		0.95		μS
t _F	Fall Time	V_{BE} (off) = -2~-3V		0.07		μS

^{*} Pulse Test: PW<350μs, Duty Cycle≤2% Pulsed

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h_{FE1} Classification

Classification	Y	G	L
h _{FE1}	135 ~ 270	200 ~ 400	300 ~ 600

Typical Characteristics

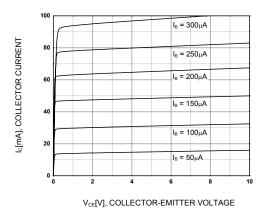


Figure 1. Static Characteristic

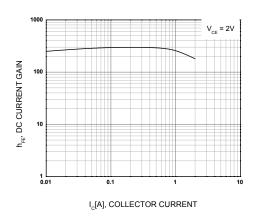


Figure 3. DC current Gain

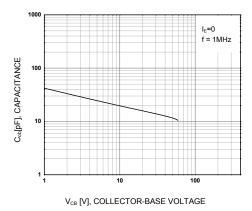


Figure 5. Collector Output Capacitance

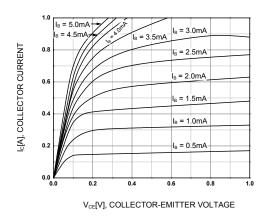


Figure 2. Static Characteristic

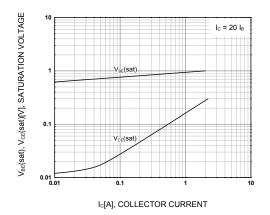


Figure 4. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

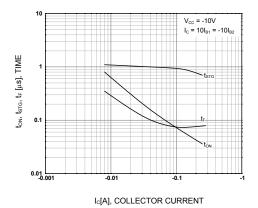


Figure 6. Switching Time

Typical Characteristics(Continued)

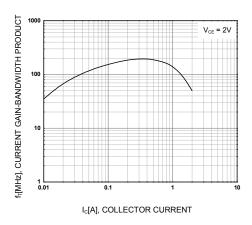


Figure 7. Current Gain Bandwidth Product

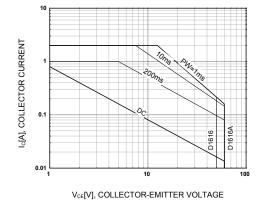


Figure 8. Safe Operating Area

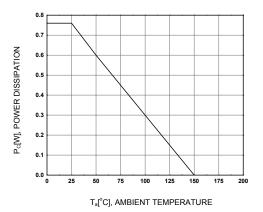


Figure 9. Power Derating





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Rev. I31